

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

Assignment ID: PATI21412

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Jinbo Chen	07/08/2022
Michael Morgan	01/22/2024
RECEIVING PARTY DATA	
Company Name:	Divergent Technologies, Inc.
Street Address:	19601 Hamilton Avenue
City:	Los Angeles
State/Country:	CALIFORNIA
Postal Code:	90502
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17522690
CORRESPONDENCE DATA	
Fax Number:	2136297401
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2136297400
Email:	patentdocket@afslaw.com,anastasia.dorr@afslaw.com
Correspondent Name:	Craig A. Gelfound
Address Line 1:	c/o ARENTFOX SCHIFF LLP
Address Line 2:	555 West Fifth Street 48th Floor
Address Line 4:	Los Angeles, CALIFORNIA 90013
ATTORNEY DOCKET NUMBER:	038191.00789
NAME OF SUBMITTER:	Anastasia Dorr
SIGNATURE:	Anastasia Dorr
DATE SIGNED:	02/12/2024
Total Attachments: 4	
source=038191.00789_Signed Assignment as filed 02.12.2024_#page1.tif	
source=038191.00789_Signed Assignment as filed 02.12.2024_#page2.tif	
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source=038191.00789_Signed Assignment as filed 02.12.2024_#page4.tif	

ASSIGNMENT

WHEREAS, I/WE:

1. Jinbo CHEN, a citizen of the **United States of America**, having a mailing address of c/o **DIVERGENT TECHNOLOGIES, INC., 19601 Hamilton Avenue, Los Angeles, CA 90502**, and a residency of the **United States of America**,

2. Michael MORGAN, a citizen of the **United States of America**, having a mailing address of c/o **DIVERGENT TECHNOLOGIES, INC., 19601 Hamilton Avenue, Los Angeles, CA 90502**, and a residency of the **United States of America**,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to

**MULTI-COMPONENT STRUCTURE OPTIMIZATION FOR COMBINING 3-D PRINTED
AND COMMERCIALY AVAILABLE PARTS**

(collectively the “**INVENTIONS**”) for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **DIVERGENT TECHNOLOGIES, INC.** (hereinafter “**ASSIGNEE**”), a corporation, having a place of business at **19601 Hamilton Avenue, Los Angeles, California 90502**, desires to acquire or otherwise obtain the entire right, title, and interest in and to said **INVENTIONS**, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto **ASSIGNEE**, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said **INVENTIONS**, including all patent applications therefor that may have been filed or may be filed hereafter for said **INVENTIONS** in the United States, including but not limited to U.S. Application No(s) **17/522,690** filed **November 9, 2021**, and all provisional applications relating thereto, (and do hereby authorize **ASSIGNEE** and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto **ASSIGNEE**, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said **INVENTIONS**, including all inventions related thereto or thereof, and all patent applications

therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which I may be entitled, or that I may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that we will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that we will not execute any writing or do any act whatsoever conflicting with these presents.

Done at Torrance, on 7/8/2022 /Jinbo Chen/
LOCATION DATE **Jinbo CHEN**

Done at _____, on _____
LOCATION DATE **Michael MORGAN**

ASSIGNMENT

WHEREAS, I/WE:

1. Jinbo CHEN, a citizen of the **United States of America**, having a mailing address of c/o **DIVERGENT TECHNOLOGIES, INC., 19601 Hamilton Avenue, Los Angeles, CA 90502**, and a residency of the **United States of America**,

2. Michael MORGAN, a citizen of the **United States of America**, having a mailing address of c/o **DIVERGENT TECHNOLOGIES, INC., 19601 Hamilton Avenue, Los Angeles, CA 90502**, and a residency of the **United States of America**,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to

MULTI-COMPONENT STRUCTURE OPTIMIZATION FOR COMBINING 3-D PRINTED AND COMMERCIALY AVAILABLE PARTS

(collectively the “**INVENTIONS**”) for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **DIVERGENT TECHNOLOGIES, INC.** (hereinafter “**ASSIGNEE**”), a corporation, having a place of business at **19601 Hamilton Avenue, Los Angeles, California 90502**, desires to acquire or otherwise obtain the entire right, title, and interest in and to said **INVENTIONS**, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto **ASSIGNEE**, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said **INVENTIONS**, including all patent applications therefor that may have been filed or may be filed hereafter for said **INVENTIONS** in the United States, including but not limited to U.S. Application No(s) **17/522,690** filed **November 9, 2021**, and all provisional applications relating thereto, (and do hereby authorize **ASSIGNEE** and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto **ASSIGNEE**, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said **INVENTIONS**, including all inventions related thereto or thereof, and all patent applications

therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which I may be entitled, or that I may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that we will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that we will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
LOCATION DATE **Jinbo CHEN**

Done at Seattle, WA, on 1/22/2024 / Michael Morgan /
LOCATION DATE **Michael MORGAN**